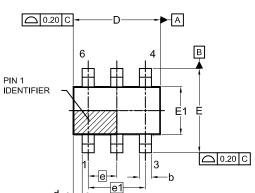
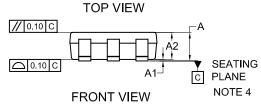
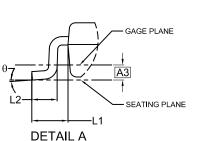


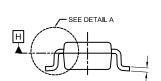
TSOT23 6-Lead CASE 419BL **ISSUE A**

DATE 31 AUG 2020









NOTES:

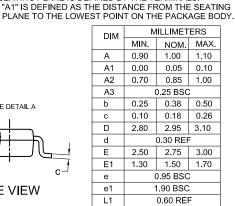
SIDE VIEW

O \ / \ 4 \ 4

	MM
	<u>e</u>
0.95	0.95
.00 MIN	
j	2.60
	l

LAND PATTERN RECOMMENDATION

*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.



1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009. CONTROLLING DIMENSION: MILLIMETERS
DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH,
PROTRUSIONS, OR GATE BURRS. MOLD FLASH,

PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.25MM PER END. DIMENSIONS D AND E1 ARE

L2

θ

0.20

0°

0.40

0.60 10°

4. SEATING PLANE IS DEFINED BY THE TERMINALS.

DETERMINED AT DATUM H.

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

= Date Code M

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.

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